

(12) INTERNATIONAL APPLICATION PUBLISHED UNDER THE PATENT COOPERATION TREATY (PCT)

(19) World Intellectual Property
Organization
International Bureau

(43) International Publication Date
21 January 2021 (21.01.2021)



(10) International Publication Number
WO 2021/010818 A1

(51) International Patent Classification:

E01C 23/00 (2006.01) *C04B 24/24* (2006.01)
E04F 15/12 (2006.01) *C04B 28/02* (2006.01)
C04B 18/14 (2006.01) *E04G 23/02* (2006.01)

TR), OAPI (BF, BJ, CF, CG, CI, CM, GA, GN, GQ, GW,
KM, ML, MR, NE, SN, TD, TG).

(21) International Application Number:

PCT/MY2020/050049

(22) International Filing Date:

08 July 2020 (08.07.2020)

(25) Filing Language:

English

(26) Publication Language:

English

(30) Priority Data:

PI2019004052 12 July 2019 (12.07.2019) MY

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(81) Designated States (unless otherwise indicated, for every

kind of national protection available): AE, AG, AL, AM,
AO, AT, AU, AZ, BA, BB, BG, BH, BN, BR, BW, BY, BZ,
CA, CH, CL, CN, CO, CR, CU, CZ, DE, DJ, DK, DM, DO,
DZ, EC, EE, EG, ES, FI, GB, GD, GE, GH, GM, GT, HN,
HR, HU, ID, IL, IN, IR, IS, IT, JO, JP, KE, KG, KH, KN,
KP, KR, KW, KZ, LA, LC, LK, LR, LS, LU, LY, MA, MD,
ME, MG, MK, MN, MW, MX, MY, MZ, NA, NG, NI, NO,
NZ, OM, PA, PE, PG, PH, PL, PT, QA, RO, RS, RU, RW,
SA, SC, SD, SE, SG, SK, SL, ST, SV, SY, TH, TJ, TM, TN,
TR, TT, TZ, UA, UG, US, UZ, VC, VN, WS, ZA, ZM, ZW.

(84) Designated States (unless otherwise indicated, for every

kind of regional protection available): ARIPO (BW, GH,
GM, KE, LR, LS, MW, MZ, NA, RW, SD, SL, ST, SZ, TZ,
UG, ZM, ZW), Eurasian (AM, AZ, BY, KG, KZ, RU, TJ,
TM), European (AL, AT, BE, BG, CH, CY, CZ, DE, DK,
EE, ES, FI, FR, GB, GR, HR, HU, IE, IS, IT, LT, LU, LV,
MC, MK, MT, NL, NO, PL, PT, RO, RS, SE, SI, SK, SM,

Published:

- with international search report (Art. 21(3))
- in black and white; the international application as filed
contained color or greyscale and is available for download
from PATENTSCOPE

(54) Title: FLOOR PATCHING COMPOSITION

(57) Abstract: A floor patching composition, comprising: 100 parts of a dry mortar composition including: 9 to 15 parts of quick-setting cement, and 85 to 94 parts of a sole fine aggregate or a combination of two or more fine aggregates, wherein the sole fine aggregate or the combination has an average true density of 2.8 to 4.0 g/cm³ and a maximum particle size of 1.2 mm or less; 3 to 18 parts of polymer emulsion solid content having a glass transition temperature (T_g) of equal to or higher than -20 °C and equal to or less than 10 °C; and 6 to 18 parts of water.

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